Power MOSFETs

Panasonic

2SK3731

N-channel enhancement mode MOSFET

Features

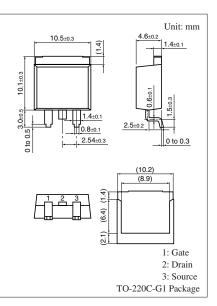
- Low on-resistance, low Q_g
- High avalanche resistance

Applications

- For PDP
- For high-speed switching

| Parameter | Symbol | Rating | Unit | | | | |
|--------------------------------|------------------|-------------|------|--|--|--|--|
| Drain-source surrender voltage | V _{DSS} | 230 | V | | | | |
| Gate-source surrender voltage | V _{GSS} | ±30 | V | | | | |
| Drain current | ID | 20 | А | | | | |
| Peak drain current | I _{DP} | 80 | А | | | | |
| Avalanche energy capability * | EAS | 668 | mJ | | | | |
| Power dissipation | PD | 50 | W | | | | |
| $T_a = 25^{\circ}$ | °C | 1.4 | | | | | |
| Channel temperature | T _{ch} | 150 | °C | | | | |
| Storage temperature | T _{stg} | -55 to +150 | °C | | | | |
| | | | | | | | |





Marking Symbol: K3731

Note) *: L = 2.79 mH, I_L = 20 A, V_{DD} = 50 V, 1 pulse, T_a = 25°C

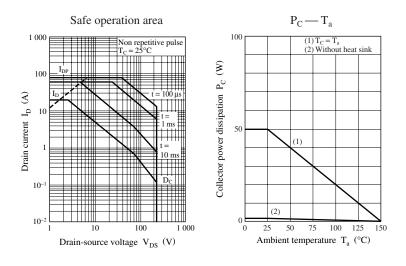
Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|---|---------------------|--|-----|-------|-----|------|
| Drain-source surrender voltage | V _{DSS} | $I_D = 1 \text{ mA}, V_{GS} = 0$ | 230 | | | V |
| Gate threshold voltage | V _{th} | $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$ | 2.0 | | 4.0 | V |
| Drain-source cutoff current | I _{DSS} | $V_{DS} = 184 \text{ V}, V_{GS} = 0$ | | | 10 | μΑ |
| Gate-source cutoff current | I _{GSS} | $V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$ | | | ±1 | μΑ |
| Drain-source ON resistance | R _{DS(on)} | $V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$ | | 65 | 82 | mΩ |
| Forward transfer admittance | Y _{fs} | $V_{DS} = 10 \text{ V}, I_D = 10 \text{ A}$ | 7 | 14 | | S |
| Short-circuit forward transfer capacitance (Common-source) | C _{iss} | $V_{DS} = 25 V, V_{GS} = 0, f = 1 MHz$ | | 2 360 | | pF |
| Short-circuit output capacitance (Common-source) | C _{oss} | | | 394 | | pF |
| Reverse transfer capacitance (Common-source) | C _{rss} | | | 49 | | pF |
| Turn-on delay time | t _{d(on)} | $V_{DD} \approx 100 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ | | 31 | | ns |
| Rise time | T _r | $R_L = 10 \Omega, V_{GS} = 10 V$ | | 27 | | ns |
| Turn-off delay time | t _{d(off)} | | | 214 | | ns |
| Fall time | t _f | | | 47 | | ns |

Electrical Characteristics (continued) $T_C = 25^{\circ}C \pm 3^{\circ}C$

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|---------------------------|-----------------------|--|-----|-----|------|------|
| Diode foward voltage | V _{DSF} | $I_{DR} = 20 \text{ A}, V_{GS} = 0$ | | | -1.5 | V |
| Reverse recovery time | t _{rr} | $L = 230 \ \mu H, V_{DD} = 100 \ V$ | | 142 | | ns |
| Reverse recovery charge | Q _{rr} | $I_{DR} = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$ | | 668 | | nC |
| Gate charge load | Qg | $V_{DD} = 100 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ | | 43 | | nC |
| Gate-source charge | Q _{gs} | $V_{GS} = 10 V$ | | 6.6 | | nC |
| Gate-drain charge | Q _{gd} | - | | 16 | | nC |
| Thermal resistance (ch-c) | R _{th(ch-c)} | | | | 2.5 | °C/W |
| Thermal resistance (ch-a) | R _{th(ch-a)} | | | | 89.2 | °C/W |

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.



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